

**Electronic Patent Application Fee Transmittal**

<b>Application Number:</b>	10541776			
<b>Filing Date:</b>	08-Jul-2005			
<b>Title of Invention:</b>	Silica-containing laminated structure, and coating composition for use in forming a porous silica layer			
<b>First Named Inventor/Applicant Name:</b>	Toshihiko Ohashi			
<b>Filer:</b>	John Wayne Bailey/Marianne Haller			
<b>Attorney Docket Number:</b>	0216-0516PUS1			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 3 months with \$120 paid	1253	1	990	990

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Request for continued examination	1801	1	810	810
<b>Total in USD (\$)</b>				<b>1800</b>